

Design Sovereignty at the Edge and for the Device

- *A European Perspective* -



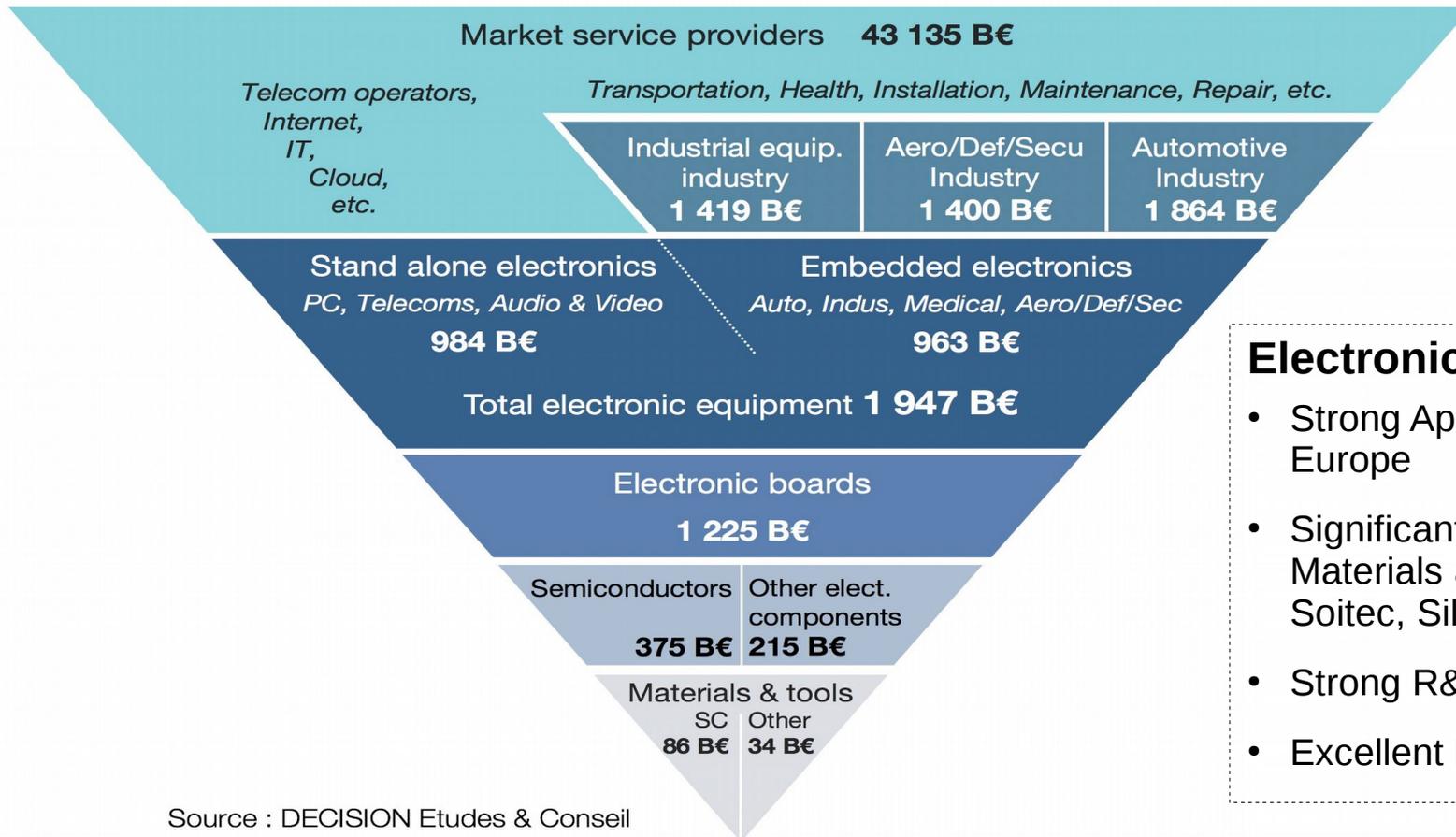
Dr.-Ing. Gerd Teepe

T3-Technologies

- What is T3-Technologies?
- The Semiconductor Growth Engine
- Semiconductor Design - Bridge between Applications and Technology
- Core Hardware
- What Europe should focus on

- Engineering Services in Microelectronics
 - Marketing: Product Description and Positioning
 - Design Projects: Construction, Setup and Management
 - Technology Consulting: Technology Choices and Benchmarks
 - R&D: Project Construction, Partner Search&Selection, Public-Funding, Project Management
- Experience of CEO:
 - 38 years of Experience in the Semiconductor Industry
 - Diploma and PhD from RWTH Aachen University (1981/1986)
 - NEC-Tokyo: Research in fault tolerant microprocessors (1986/87)
 - Motorola: Design, Design Management, Marketing, Product Management (1987-2004)
 - AMD: Direction of Dresden Design Center (2004 - 2009)
 - GLOBALFOUNDRIES: Design Enablement Center, Technology Marketing (2010 - 2018)

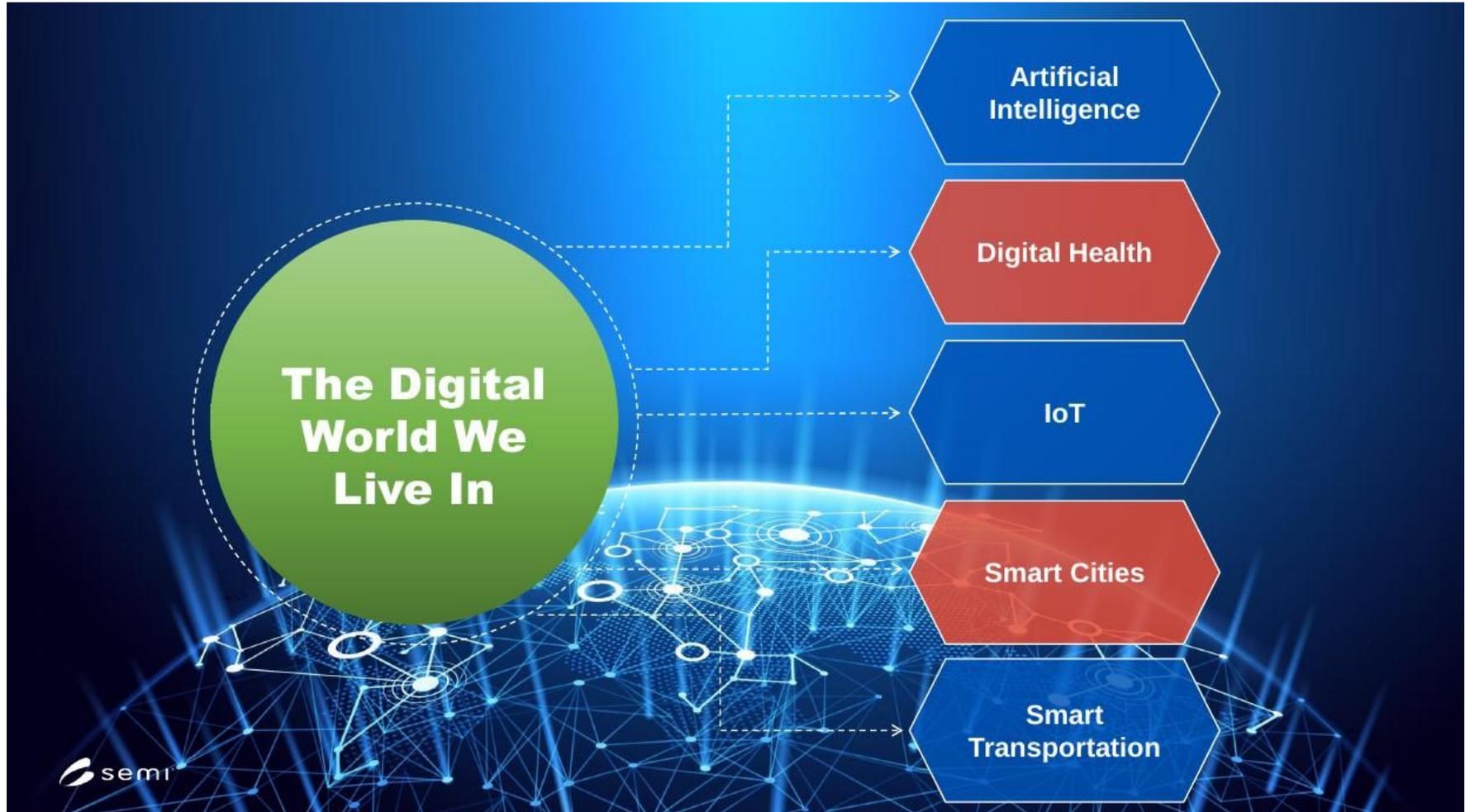
Worldwide Electronics value chain in 2017



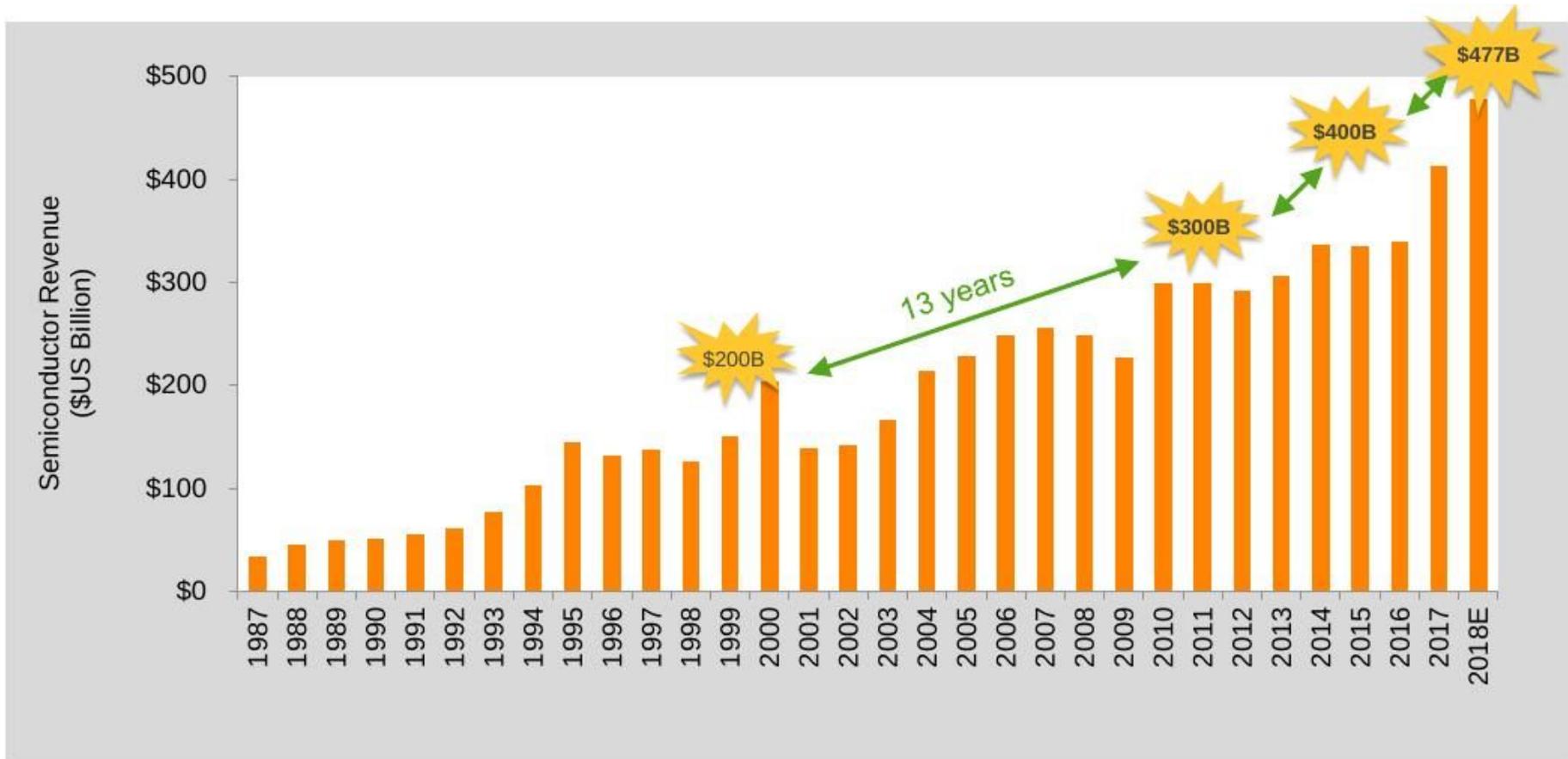
Electronics Value Chain

- Strong Applications Industries in Europe
- Significant Contributions globally in Materials and Tools (e.g. ASML, Soitec, Siltronic, ...)
- Strong R&D in Materials
- Excellent European Infrastructure

Source : DECISION Etudes & Conseil



Semiconductor Industry Revenues



Source: SIA/WSTS historical year end reports, WSTS Autumn Forecast November 2018

Source: ICINSIGHTS, July 2018 report

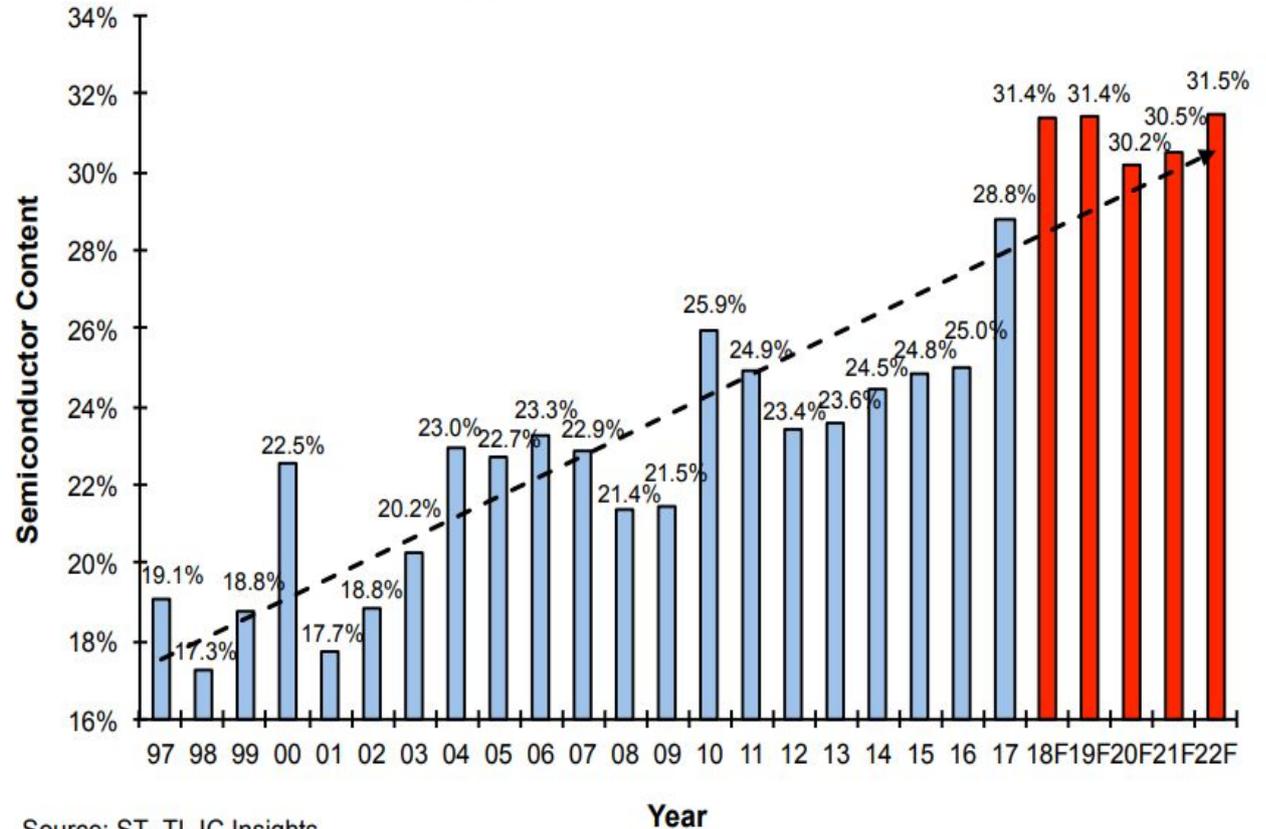
The electronic system content is on the rise.

Microelectronics is key in defining the product features.

It has been the case for Telecom products (like smartphones) but now we see it happening for industrial and consumer products.

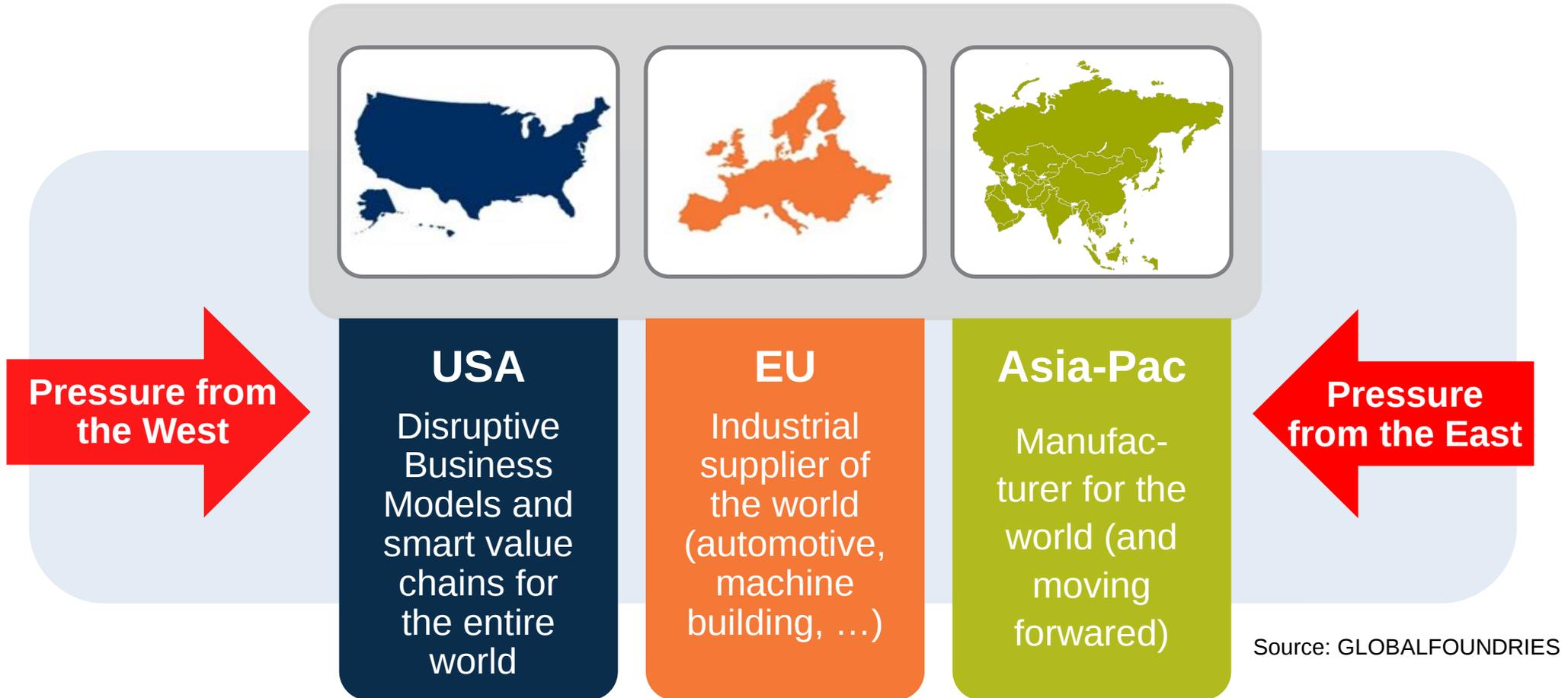
(Automobiles, Home-robotics, Toys&Games, White Goods, Medical Applications)

Electronic System Semiconductor Content



Source: ST, TI, IC Insights

Europe is in a Sandwich Position



Source: GLOBALFOUNDRIES



Technology

22FDX

14FF

RF

Applications

Automotive

Industrial

Energy

Telecom

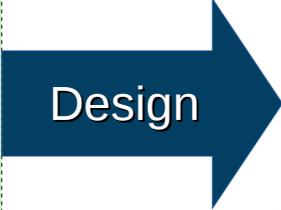
IoT

Design Bridge

Technology Sovereignty

- Architectures (Microprocessor-Cores, Networks, Connectivity)
- Semiconductor Manufacturing
- Packaging & Assembly
- Supply Chain
- Security
- Data Sovereignty

Design



Application Sovereignty

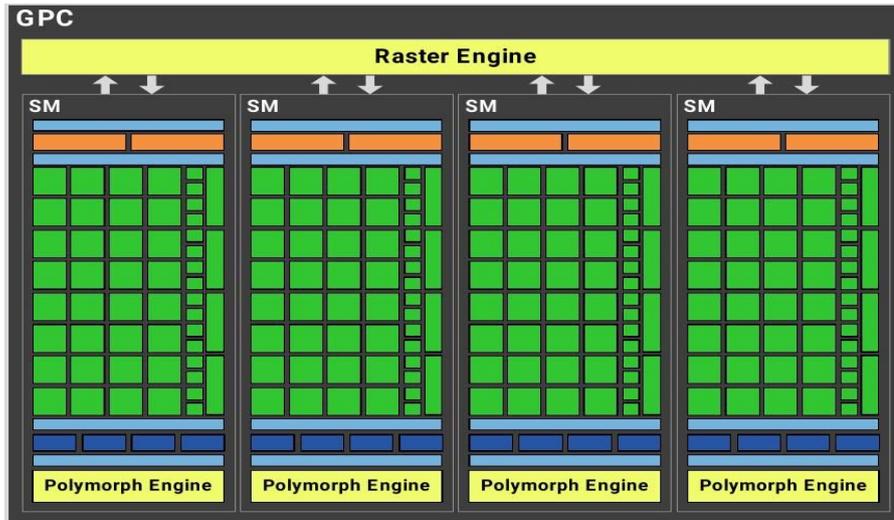
- Artificial Intelligence
- 5G/6G (Network Applications)
- IoT
- Digital Health
- Transportation
- Smart Cities

Scaling in Computing

Entity	Multiple	1st App	Scale-up		
CPU	Multi-Core	PC	Compute-Cluster	Data-Center	Cloud
		Network Switch	Network		Edge
		Embedding --- Device			
Simple CPU	GPU (SIMD)	Co-Processing	Scale up		
MAC	TPU (SIMD)				
Mac or Neuro	NPU (MIMD)				

Distributed versus Parallel Computing

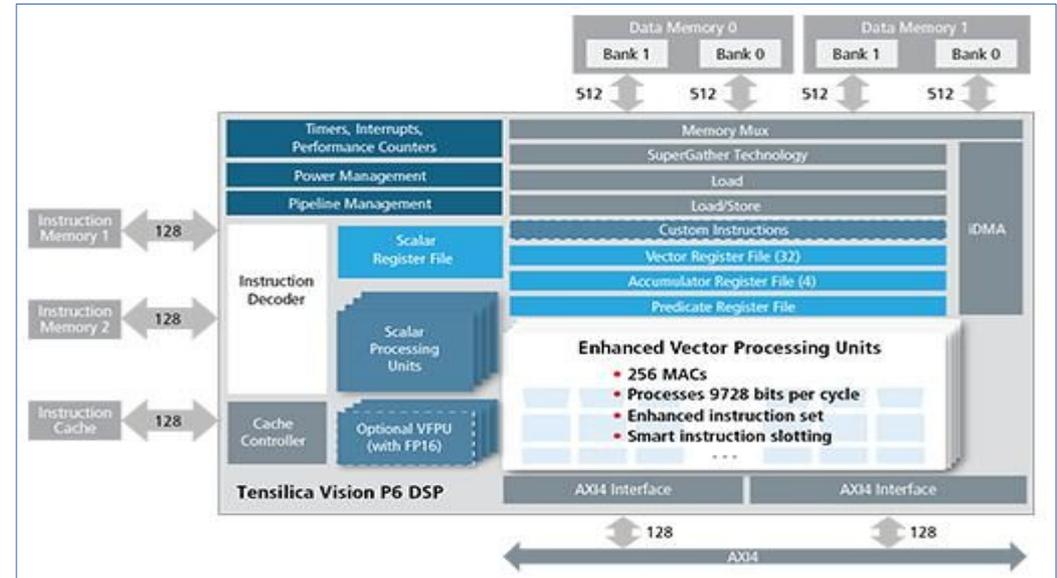
Attribute	Parallel Computing		Distributed Computing	Neuromorphic
Example system topology	SMP	MPP	1) Internet 2) Data Center	Human Brain
Programming	P-threads OpenMP	Message Passing (MPI)	HTTP XML/SOA Mash-up APIs	Machine Learning
Industry leaders	IBM, Sun, HP servers	HPC Niche	Google, Yahoo, MS Live	- none as of yet -
Scalability	Poor	Moderate	Outstanding	Outstanding
Fault Tolerance	Failures are fatal	Failures are feared	Failures are <u>assumed</u> in the architecture	Failures are <u>worked</u> into the production system (yield)
Progress assessment over last 30 yrs	Very poor	Moderate	Substantial	Significant progress since the early analog work



Source: Nvidia GPC

GPU Engines

- Up to 5000 integer cores
- Integer Data Flows
- Main Application: Gaphics-Shading

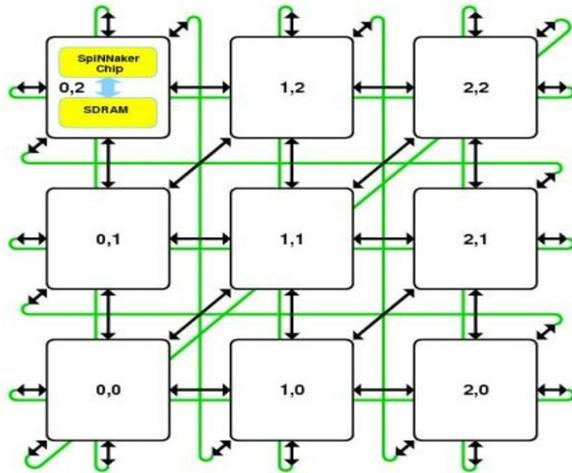


Source: Cadence Tensilica Vision-P6

CNN-Engines

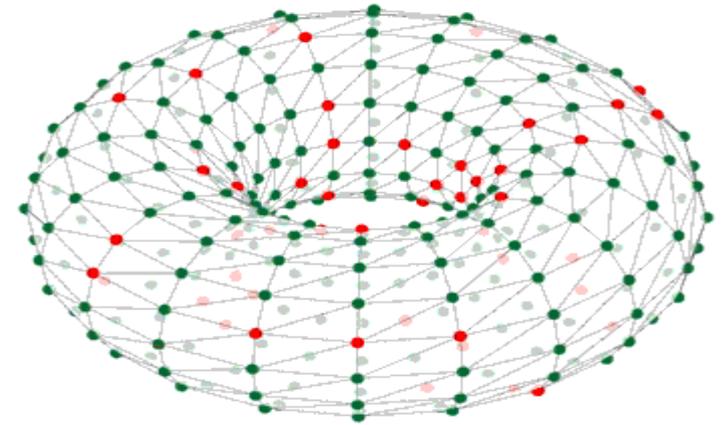
- 256 MAC units (and more)
- SIMD-Architecture
- Main Application: Image Recognition

Modeling the Human Brain: Computing within the Memories



The SPINNACKER Project

Up to 500.000 connected ARM processors



The Human Brain Project (HBP)

Torus of connected compute elements including memories

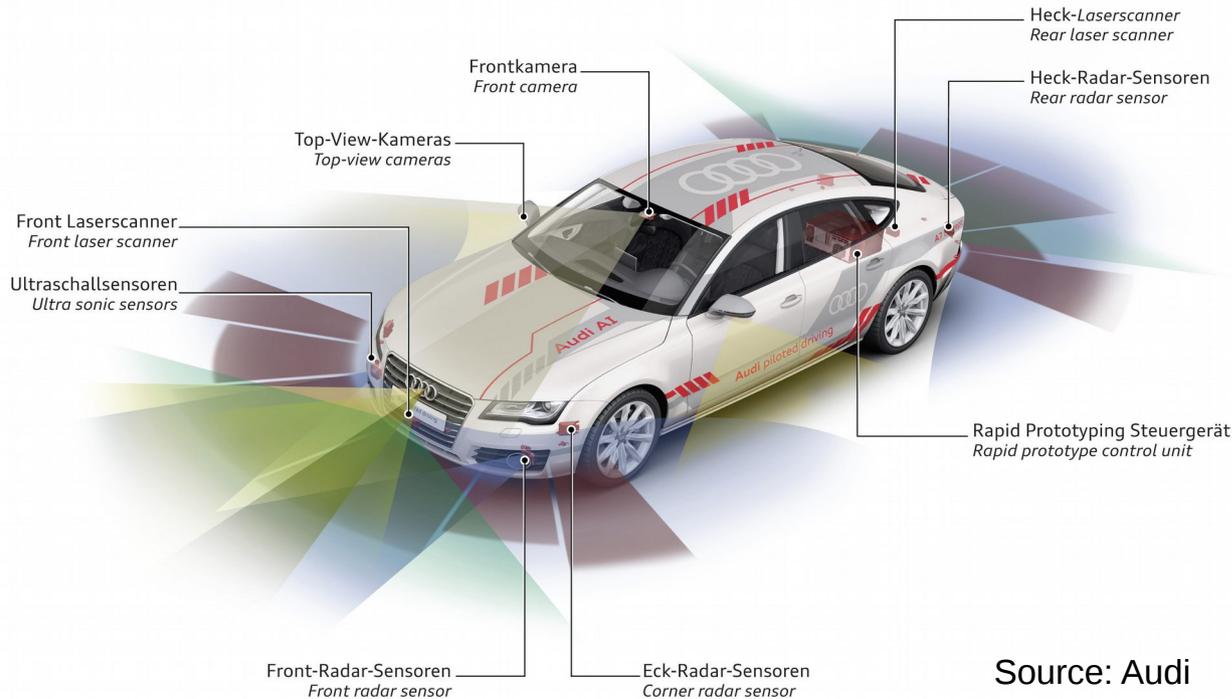
USA: Darpa Synapse Program

Core Landscape Today

Core Family	Source	AI	5G-6G	Device	Edge	Cloud	Comment
X86	Intel, AMD				○	●	PC, Server, Cloud
ARM	ARM	○	●	●	●	○	Initially from Telecom-Device
RISC-V	Open Source	●	●	●	●	○	..the new LINUX for hardware?
Tensilica	Cadence	●	○	○			Intended for flexibility in design
Tegra	Nvidia	●		●	○		Proven AI architecture
ARC	Synopsys		○	●			Will this break through?

Audi A7 piloted driving concept

Sensoren- und Kamerasystem
Sensors and camera system
05/16



Source: Audi

Audi Architecture

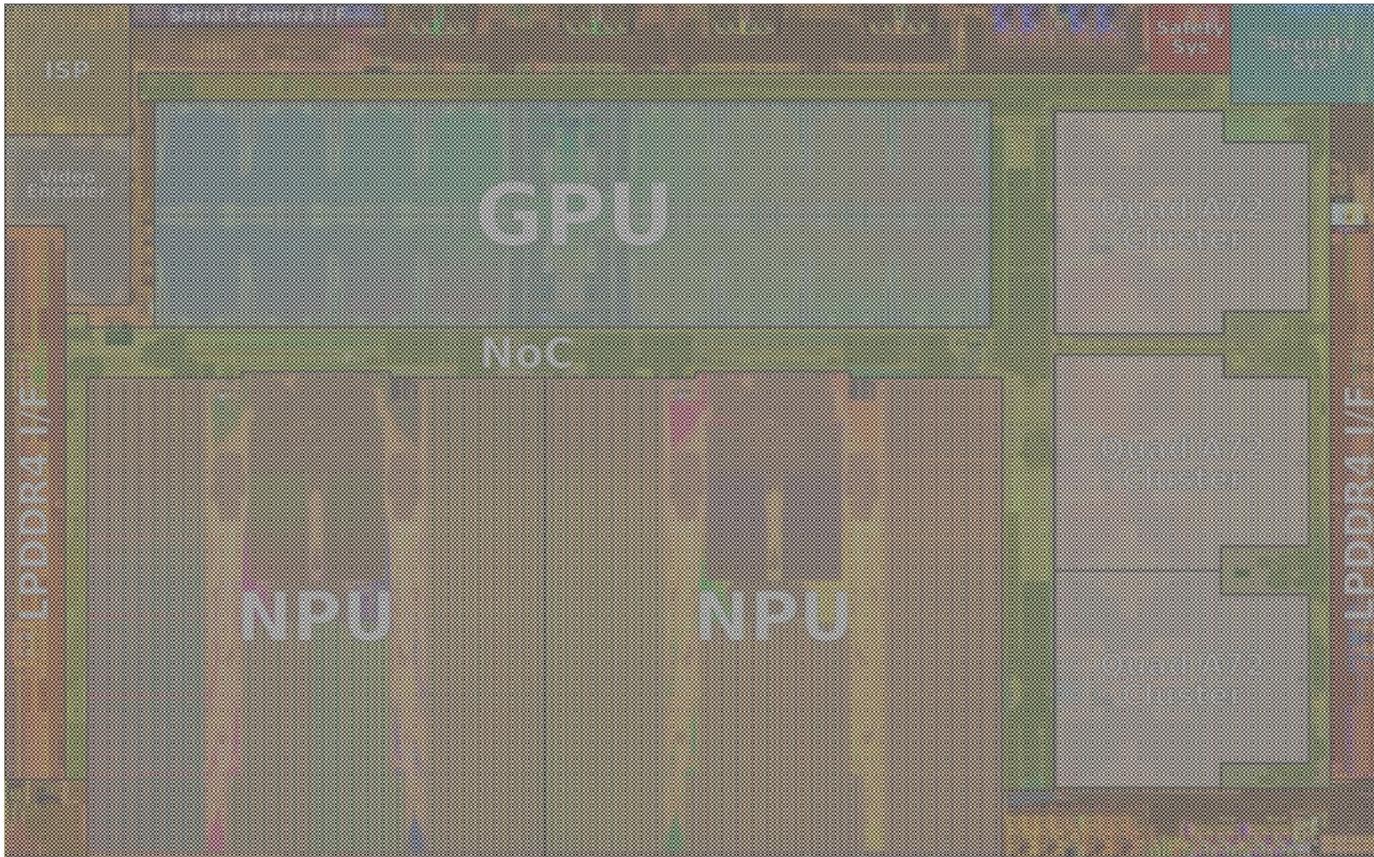
- Sensor based (Image, Radar, Lidar)
- Data Fusion
- ZFAS central unit
- Massively parallel computing



Source: Audi

AUDI ZFAS Electronic Control Unit

- Driver Assistance Controller
- Data-Fusion using AI-Methodology
- Nvidia Tegra K1 Architecture
- Automotive Qualification
- Automotive Power Footprint



Source: TESLA

FSD – Full Self Driving

- 14nm Finfet Technology
- 144 TOPS
- 72 Watt TDP
- 12 ARM Cortex A72
- 2 NPU (Neural Network Accelerator)
- LPDDR4-I/F
- Encryption
- Safety-Supervision

- Design is the bridge between Product and Technology
- General Purpose Devices are vanishing – If you don't design it, you don't get it.
- Sovereignty means choice of Value Chain in:
 - Production
 - Design
 - Tooling
 - Materials
 - Packaging
- “Open Source” is starting to become an alternative

Thank You